

DATA SHEET

ES-24-XQ38-1050-XXXXX

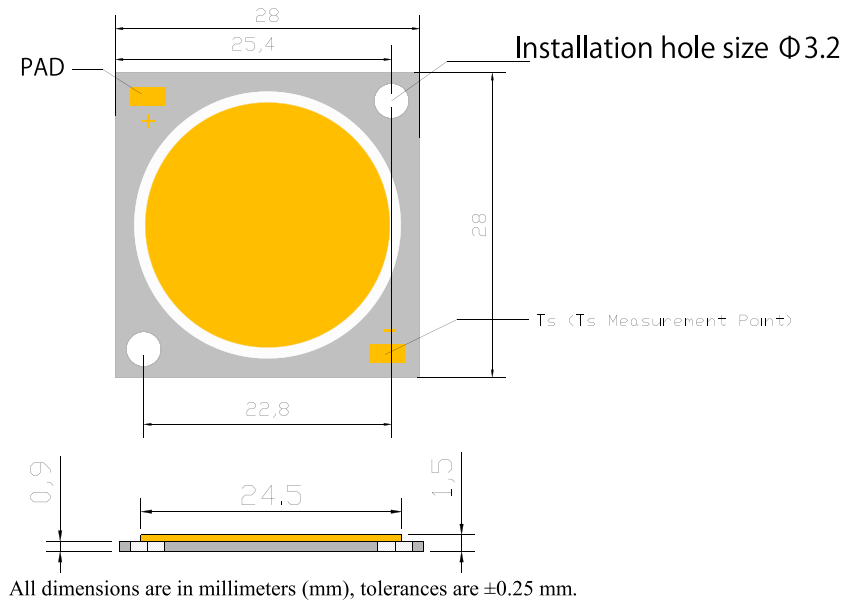
CONTENTS

1.	Introduction	2
2.	Mechanical Dimensions.....	2
3.	Features & Applications.....	3
4.	Electro Optical Parameters.....	4
5.	Limit Parameters.....	4
6.	Chromaticity Co-ordinate.....	5
7.	Characteristic and curves	6
8.	Encoding.....	8
9.	Packaging specification.....	9
10.	Cautions.....	10

1. Product Description

Our product has excellent reliability & high quality. Everstar COB series covers a wide range of luminous flux. The element arrangement of LED package is capable of utilizing light more effectively with higher performance.

2. Mechanical Dimensions



2. Features & Applications

FEATURES

- High color quality, high flux, high efficacy
- Low thermal resistance
- Long lifetime
- Easy for assemble
- RoHS compliant
- Available white chromaticity bins form ANSI

APPLICATIONS

- LED bulb lights
- LED spot lights
- LED recessed lights
- LED miner lights
- Commercial lighting,
- Domestic lighting
- and museum lighting.

4. Electro Optical Parameters

Nominal parameters(Ta=25°C)

Parameters	Conditions	Min	Typ	Max	Unit
Forward V	IF=1050mA	34	36	40	V
Forward A		720	1050	1800	mA
Luminous flux IF=1050mA	TC=2700K	4060	4260	4660	LM
	TC=3000K	4850	5160	5400	
	TC=4000K	5050	5370	5700	
	TC=5000K	-	-	-	
	TC=5700K	-	-	-	
	TC=6000K	4950	5270	5590	
	TC=6500K	-	-	-	
Power	IF=1050mA	-	38	57	W
Ra		80	-	-	

Note :

- 1) device tolerance for luminous flux:±4%
- 2) device tolerance for color coordinate:±0.002
- 3) device tolerance for forward voltage:±0.1V
- 4) device tolerance for angle :±5 degrees

5. Absolute Maximum Ratings

Item	Symbol	Min	Typ.	Max	Unit
Operating Temperature	T_{opr}	- 10	/	+85	°C
Storage Temperature	T_{stg}	- 40	/	+100	°C
Soldering Temperature	T_{sol}	/	/	350	°C
Junction temperature	T_j	/	/	125	°C
Thermal Resistance	R_{j-c}	/	/	1.34	°C /W
Antistatic Ability	ESD	2000	/	/	V

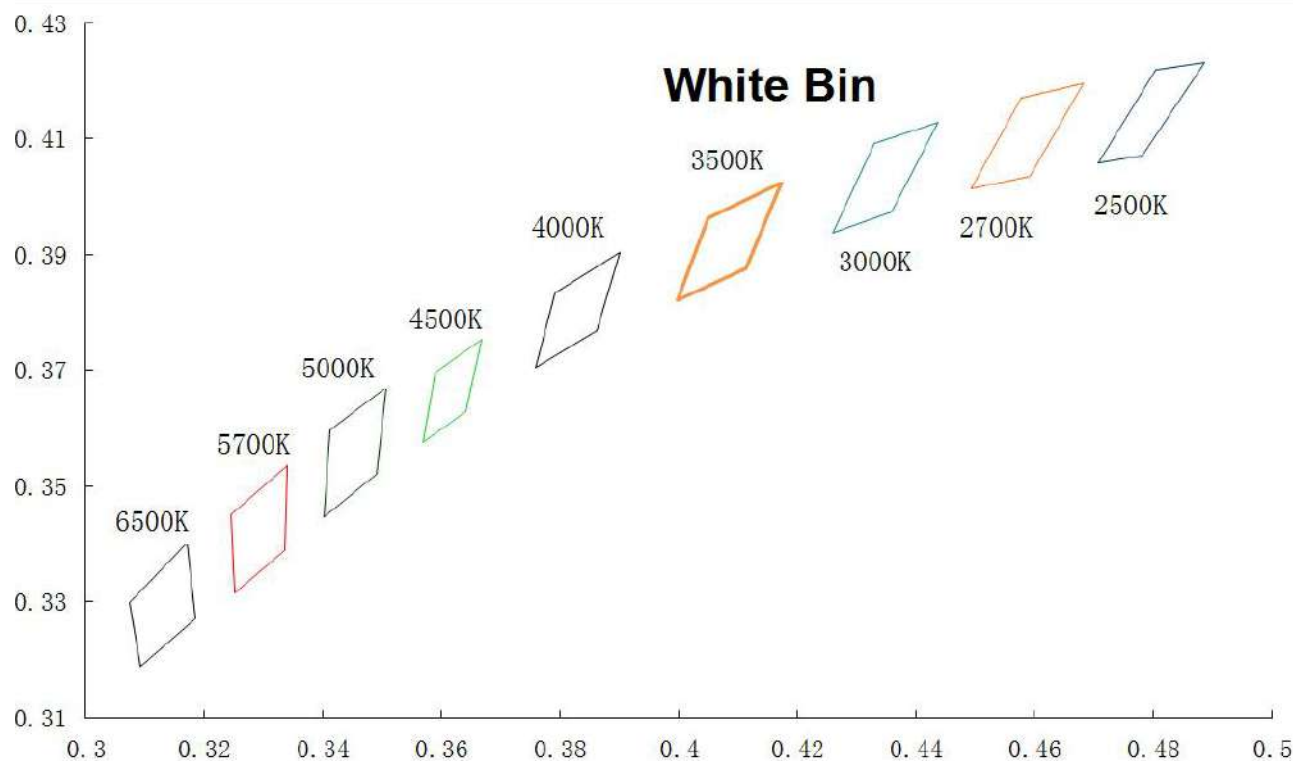
Note:

The temperature of Aluminum PCB do not exceed 85°C.

When hand soldering, keep the temperature of iron below 350°C and for less than 5 seconds

6. Chromaticity Coordinate Groups

7. White bins on CIE-1931 (Ta=25°C)



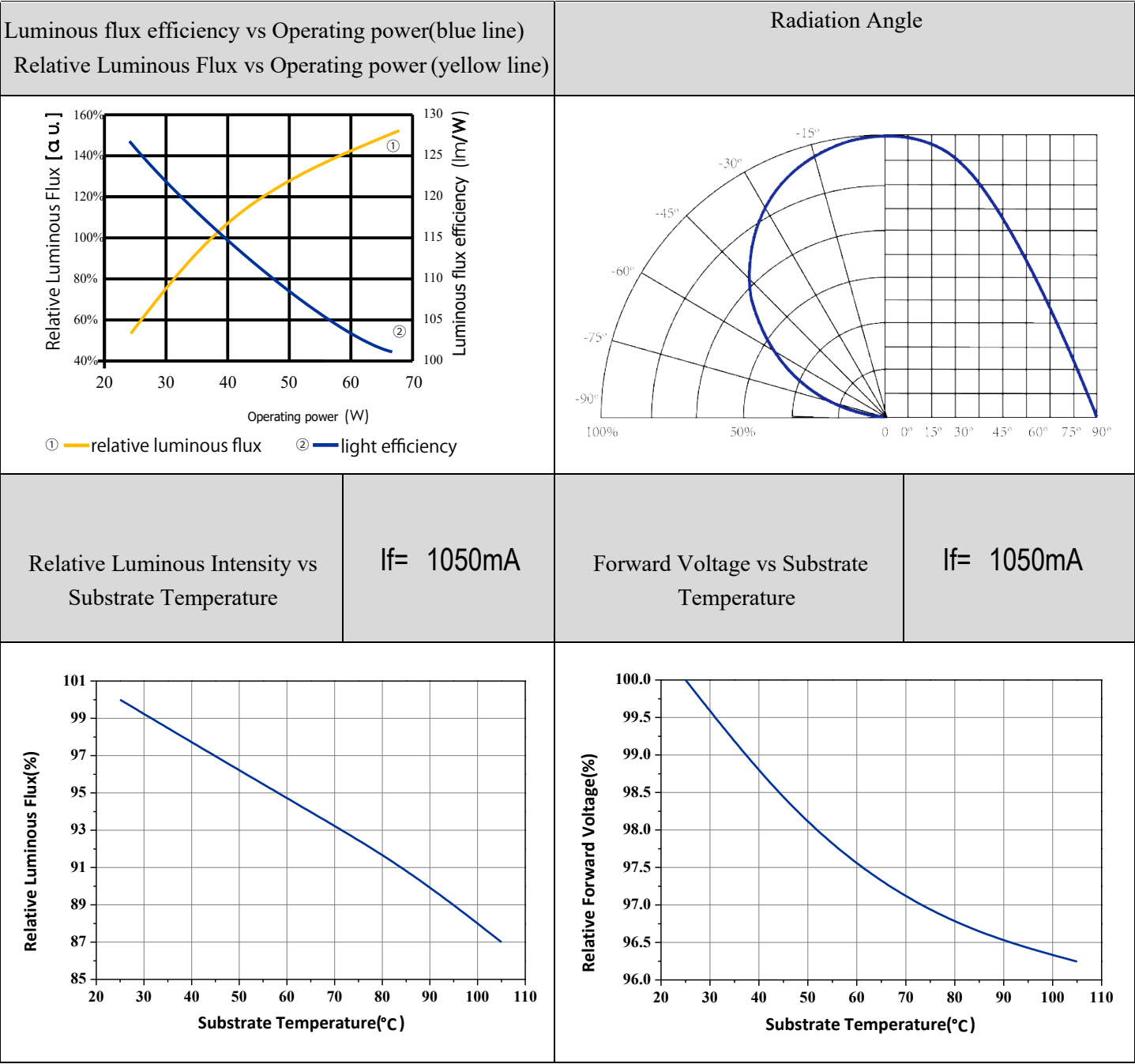
Color Temperature and BIN

CT	2500K	2700K	3000K	3500K	4000K	4500K	5000K	5700K	6000K	6500K
CT Range	2410-255	2640-281	2940-314	3330-358	3820-412	4375-463	4840-520	5400-590	5700-630	6150-685
CT Factor	±70	±85	±100	±125	±150	±130	±180	±250	±300	±350
Center CT	2480	2725	3045	3465	3985	4503	5028	5665	6000	6530

6500K	0.3178	0.3336	0.3184	0.3271	0.3093	0.3188	0.3084	0.3243
6000K	0.3152	0.3370	0.3167	0.3241	0.3277	0.3330	0.3274	0.3470
5700K	0.3338	0.3463	0.3336	0.3390	0.3251	0.3315	0.3248	0.3383
5000K	0.3498	0.3595	0.3490	0.3520	0.3401	0.3446	0.3406	0.3521
4500K	0.3667	0.3753	0.3654	0.3691	0.3579	0.3636	0.3589	0.3697
4000K	0.3901	0.3904	0.3881	0.3836	0.3774	0.377	0.3791	0.3835
3500K	0.4173	0.4025	0.4143	0.3951	0.4023	0.3892	0.4048	0.3963
3000K	0.4436	0.4129	0.4397	0.4051	0.4294	0.4015	0.4328	0.4092
2700K	0.4681	0.4196	0.4636	0.4116	0.4535	0.4092	0.4577	0.4171
2500K	0.4885	0.4232	0.4833	0.4152	0.414	0.422	0.4885	0.4232

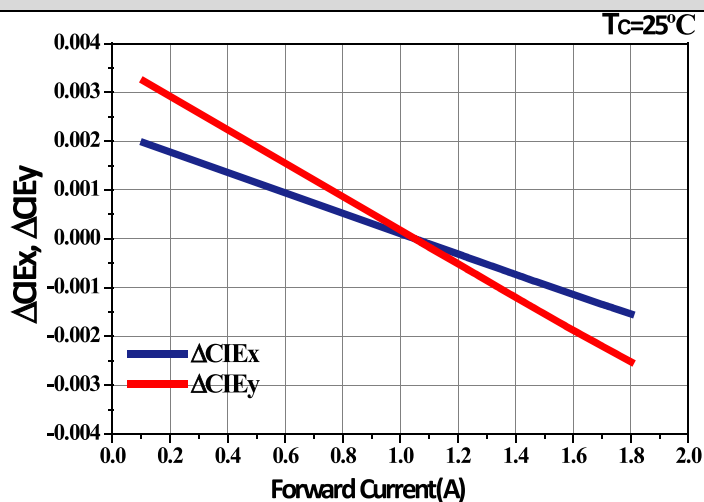
7. Characteristic Curves

Forward Current / Radiation/ Temperature Characteristics

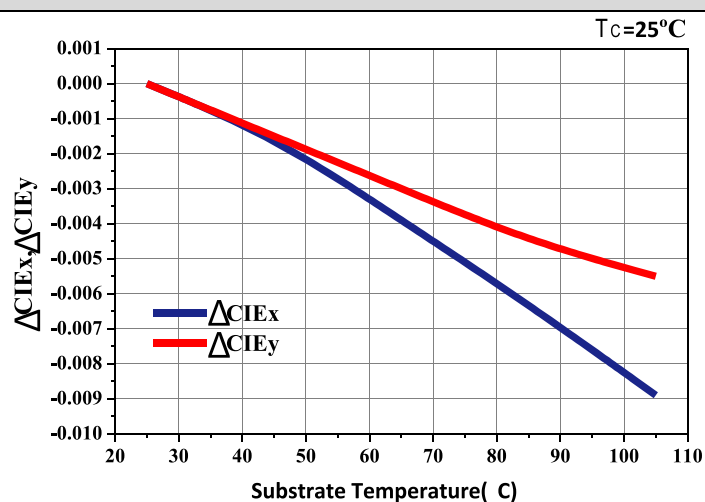


Color Shift Characteristics

$\Delta CIE_x, \Delta CIE_y$ vs Forward Current
CRI(Ra)=80 $T_c=25^\circ\text{C}$ $I_f=1050\text{mA}$



$\Delta CIE_x, \Delta CIE_y$ vs Substrate Temperature
CRI(Ra)=80 $T_c=25^\circ\text{C}$ $I_f=1050\text{mA}$

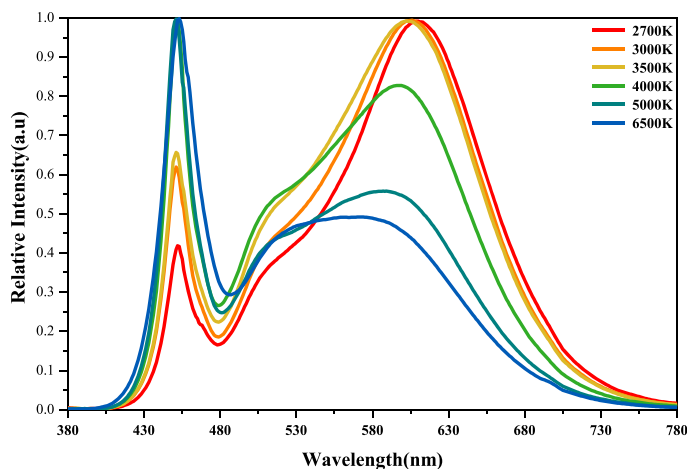


Spectrum Distribution

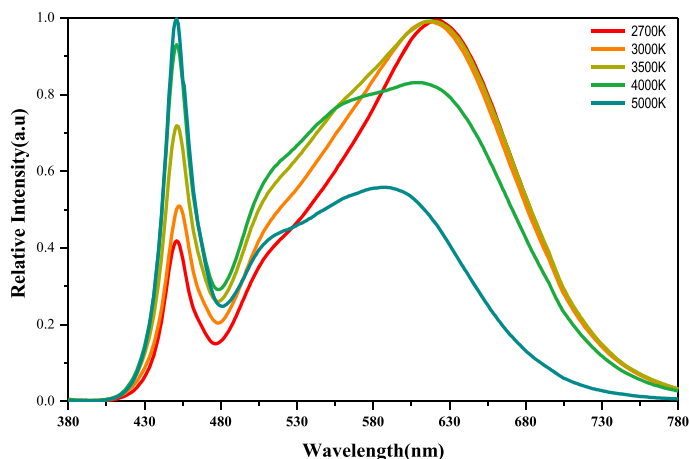
Relative Intensity vs Wavelength

 $I_f=1050\text{mA}$

CRI(Ra) 80Min



CRI(Ra) 90Min




8. Encoding

XX- XX - XX XXX-XXXX-XX XX X
 [1] [2] [3] [4] [5] [6] [7] [8]

[1]	(Product code)
[2]	(Emitting Surface Code)
[3]	(Product Series Type Example LQ)
[4]	(Power) e.g.24W 024
[5]	If typical Current (mA)
[6]	(CCT) e.g.R3000K 30
[7]	(CRI) 80
[8]	(Revision) e.g.A

9 Packing Specification

Label information



COB XXW XXXXK

TYPE

XX- XX - XX XXX-XXXX-XX XX X

IF: XXX mA VF: XX- XX V

TC: XXXXX K ϕ : XXX- XXX lm

LOT NO.: XXXXXXXXX- XXXXX

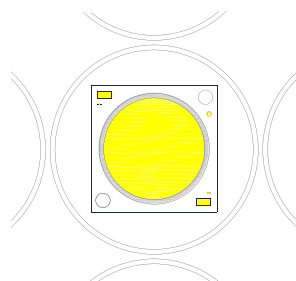
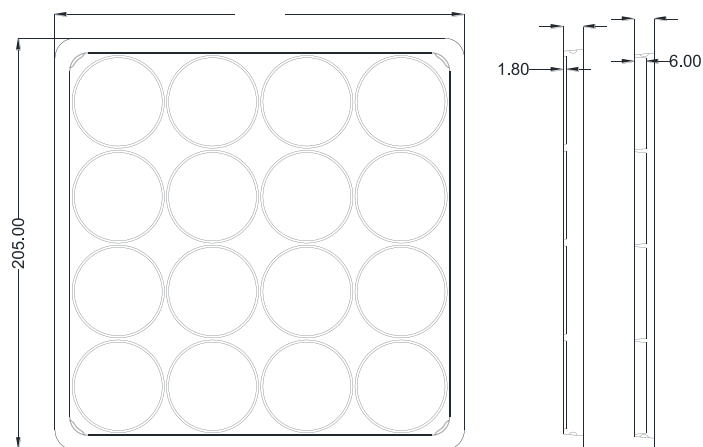
XXX PCS

(1) Product encoding

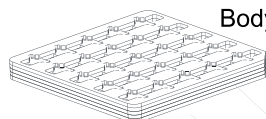
(2) Lot number
 17068888 17 6
 E.g. 17:year 16 06:June

(3) Quantity

Manner of packing



Cover Tray(1sets)

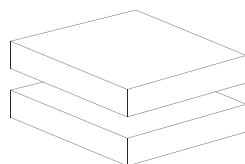


Body Tray(5 sets)

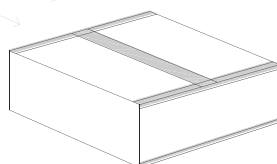
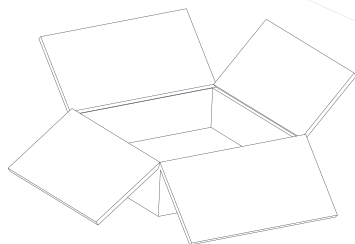
5 body Tray / MBB bag
(MBB-BAG : Heat Sealing)



MBB bag
Heat Sealing



8/9/16/18 bags / box



An electrostatic bag contains
five sets, and a set contains
16 PCS COB .(Smallest packing
unit:80 PCS)

A label whit product
name, quantity and lot
number is placed on the
electrostatic bag.(Tray
Dimension: 205*205*8
mm)

10. Cautions

Storage

Store the parts in a dry, nitrogen- purged cabinet or container that actively maintains the temperature at 20 - 30 and the RH at no greater than 60%.

Precautions for Use

By using anti - static - electricity bracelets/ cushions/ overalls/ shoes/gloves and anti - static - electricity containers, it can effectively prevent static electricity and surge.

The soldering iron point should be properly grounded. When hand soldering, keep the temperature of iron below less 350°C and less than 5seconds.

ESD Protection

You need to take the protective measures for the product being sensitive to static electricity. It can lead to product damage electricity is beyond the maximum rating. The ground resistance if the high voltage current made by static can't beyond 10 Ω .

Cleaning

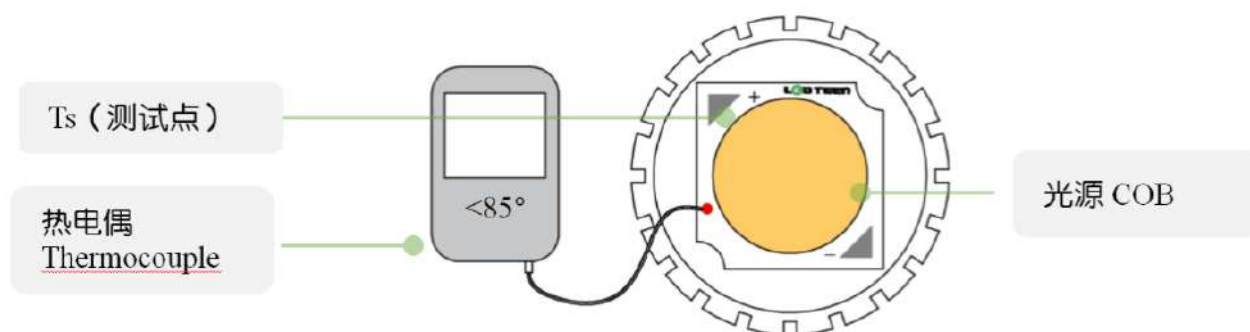
Please do not make the thermal grease, oil exposed to the light-emitting surface. Airgun can be used to remove dirt. Gun's Pressure: 0.5MPa, Time: 1 to 2 seconds, Distance: more than 20cm.

Overcurrent Protection

It is recommended to design PCB with ground circuit. Pay special attention to the operating environment of the products: Humidity must be between 50% and 80%, or else electrostatic breakdown and overcurrent damage occur. The operating temperature is -10°C ~ 85°C. When using this product, please observe the absolute maximum ratings and the instructions for operating outlined in these data sheets. Company do not assume any responsibility for any damage, resulting from use of product which does not comply with the absolute maximum rating. maximum ratings and the instructions included in these data sheets.

Thermal Design

The thermal design to draw heat away from the LED junction is most critical parameter for an LED illumination system. High operating temperatures at the LED junction adversely affect the performance of LED's light output and lifetime. Therefore the LED junction temperature should not exceed the absolute maximum rating in LED illumination system.



Safety Tips

During using this product, the country relative safety standards (eg. GB7000.1 - 2007) should be accorded with. We will not be liable for the users' acts of non - observance of the country safety standards.